



# 2021 APPLICATION

## MCBRIDE REMODELING SCHOLARSHIP



Michigan  
Technological  
University

# MCBRIDE REMODELING SCHOLARSHIP APPLICATION

## Michigan Tech Summer Youth Programs

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### PROGRAM INFORMATION

Founded in 1972, Michigan Technological University's Summer Youth Programs (SYP) offers middle and high school students opportunities for hands-on learning and career exploration in a wide-variety of fields and to experience college life in a fun, engaging, and safe setting. We aspire to spark curiosity, discovery, and critical soft skill development in exceptional young people from around the world.

This scholarship is available to students currently in 6-11 grade and currently attending one of the following schools: Flint Public Schools, Harbor Springs School District, Petoskey Public Schools, Petoskey charter schools, or a Petoskey parochial school. This scholarship is available for ten (10) students to select any SYP tuition-based course with seats remaining excluding competitive scholarship programs.

A complete list of 2021 courses is available at: [mtu.edu/syp/discover/courses](https://mtu.edu/syp/discover/courses)

### COST

All selected participants receive a scholarship valued at \$500 to apply towards cost of tuition, classroom supplies, and room and board. In addition, this scholarship also covers the cost for the SYP charter bus from Novi, MI (covers bus round trip, a \$225 value), if needed. The remainder of the tuition will be your responsibility and will be due June 1. A nonrefundable \$100 registration fee is due within ten days of acceptance, to be paid by the scholarship recipient. Do not send your payment with your application. If accepted, we must receive your registration fee to complete your enrollment and guarantee your spot. Total program costs to participants will vary depending on the exploration they select, but begins at \$478 for regular Summer Youth Program courses. You are responsible for your own transportation costs if you choose not to ride the SYP charter bus.

### SELECTION CRITERIA

Open to students who are currently in grades 6-11 and attending either the Flint Public Schools, Harbor Springs School District, Petoskey Public Schools, Petoskey charter schools, or a Petoskey parochial school. Participants are selected on a competitive basis. Preference will be given to applicants who are academically successful and have demonstrated a strong interest in their chosen camp or exploration subject.

### HOW TO APPLY

The application deadline is 5 PM (EST) Monday, March 1, 2021. The selection committee will meet one week after the deadline to review applications.

Please submit your completed application and short responses to us by:

Email: [syp@mtu.edu](mailto:syp@mtu.edu)

or

Mail: Michigan Tech Summer Youth Programs

Administration Building 217

1400 Townsend Drive

Houghton, MI 49931-1295

### APPLICATION CHECKLIST

Completed application

Short responses to questions

Signature of parent or guardian

Signature of applicant

**SUBMIT YOUR APPLICATION AND CONTACT OUR OFFICE WITH ANY QUESTIONS.**

Michigan Tech Summer Youth Programs  
Administration Building 217  
1400 Townsend Drive  
Houghton, MI 49931-1295

Toll-free 888-773-2655  
[syp@mtu.edu](mailto:syp@mtu.edu)

[mtu.edu/syp](https://mtu.edu/syp)

# MCBRIDE REMODELING SCHOLARSHIP APPLICATION

**Application deadline is 5 PM (EST) Monday, March 1, 2021.** Late applications may be considered if additional scholarships become available, but the scholarship will be awarded first come, first-served basis. Please complete both sides of this application and send it with your short responses to questions. A \$100 registration fee will be due within 10 days of being accepted into the program to complete your enrollment. **Do not send your payment now.**

Legal name \_\_\_\_\_  
First M. I. Last Suffi (Jr., Sr., II, etc.)

Preferred name/nickname \_\_\_\_\_  
This is how your name will appear on your participant ID.

## EXPLORATION SELECTION

Please list your top choices for explorations you would like to be considered for if selected for this scholarship.

| Course Number  | Course Name          | Course Date    |
|----------------|----------------------|----------------|
| Example: 51201 | Chemical Engineering | June 27-July 3 |
| 1. _____       | _____                | _____          |
| 2. _____       | _____                | _____          |
| 3. _____       | _____                | _____          |

## CONTACT INFORMATION

Participant's email \_\_\_\_\_  
 Address/PO Box \_\_\_\_\_  
 City \_\_\_\_\_  
 State/province \_\_\_\_\_ ZIP or postal code \_\_\_\_\_  
 County \_\_\_\_\_ Country \_\_\_\_\_  
 Home phone \_\_\_\_\_  
 Participant's cell phone \_\_\_\_\_

## SCHOOL INFORMATION

What is the name of the school you attended this year?  
 \_\_\_\_\_  
 School Address \_\_\_\_\_  
 City \_\_\_\_\_ State/province \_\_\_\_\_  
 Zip or postal code \_\_\_\_\_ Country \_\_\_\_\_  
 What grade will you have completed by June 2021? \_\_\_\_\_  
 Current class rank \_\_\_\_\_ out of \_\_\_\_\_ Cumulative GPA \_\_\_\_\_  
**Note:** If your school uses a grading system other than the 4.0 scale, an explanation of the method must accompany your transcript.

## PERSONAL INFORMATION

Gender \_\_\_\_\_ Birth date \_\_\_\_\_ Age \_\_\_\_\_

Does participant have relatives who graduated from Michigan Tech? Please list their name, class year, and relation to you.

|            |                  |                |            |                  |                |
|------------|------------------|----------------|------------|------------------|----------------|
| Name _____ | Class year _____ | Relation _____ | Name _____ | Class year _____ | Relation _____ |
| Name _____ | Class year _____ | Relation _____ | Name _____ | Class year _____ | Relation _____ |

## PARENT/GUARDIAN INFORMATION:

Parent first name \_\_\_\_\_ M. I. \_\_\_\_\_ Last name \_\_\_\_\_ Suffi \_\_\_\_\_

Relationship to applicant \_\_\_\_\_

Evening phone \_\_\_\_\_ Day phone \_\_\_\_\_

Cell phone \_\_\_\_\_ Email \_\_\_\_\_

Is your address the same as the participant's?  Yes  No

Parent first name \_\_\_\_\_ M. I. \_\_\_\_\_ Last name \_\_\_\_\_ Suffi \_\_\_\_\_

Relationship to applicant \_\_\_\_\_

Evening phone \_\_\_\_\_ Day phone \_\_\_\_\_

Cell phone \_\_\_\_\_ Email \_\_\_\_\_

Is your address the same as the participant's?  Yes  No

# MCBRIDE REMODELING SCHOLARSHIP APPLICATION

PLEASE TYPE OR PRINT YOUR SHORT RESPONSES TO THE QUESTIONS BELOW ON A SEPARATE PIECE OF PAPER.

Be sure to put your full name and that you are applying for the McBride Remodeling Scholarship at the top of the page.

1. List your current courses and the courses you plan to take next. Please explain which class you are looking forward to the most and why.
2. Describe your involvement in any extracurricular activities, hobbies, or community organizations.
3. Write a statement (**250 words or more**) discussing why it is important to you to have this experience? Why did you choose the SYP exploration(s) you indicated?
4. What excites you about this opportunity? Please explain a problem or question you want to explore in science, technology, engineering, and/or math (STEM).

## HOW DID YOU HEAR ABOUT OUR PROGRAM?

- |  |  |
|--|--|
| <input type="checkbox"/> Counselor or teacher          | <input type="checkbox"/> Internet search                       |
| <input type="checkbox"/> I am a previous participant   | <input type="checkbox"/> Michigan Tech alumni or faculty/staff |
| <input type="checkbox"/> Summer Youth Programs website | <input type="checkbox"/> Mind Trekkers event                   |
| <input type="checkbox"/> Friend                        | Date and place   |
| <input type="checkbox"/> Catalog                       | <input type="checkbox"/> Other _____                           |
| <input type="checkbox"/> Social media                  | _____  |

## PARENT/GUARDIAN CONSENT

I approve of \_\_\_\_\_ applying to SYP's McBride Remodeling  
Scholarship. *Print applicant name*

Signature \_\_\_\_\_ Date \_\_\_\_\_

## STUDENT SIGNATURE

I attest that the information provided in this application is correct.

Signature \_\_\_\_\_ Date \_\_\_\_\_